



Surface Mount General Purpose Rectifier





Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- Switching for general purpose
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

Typical Applications

For use in general purpose switching rectification of power supply, inverters, converters, and freewheeling diodes for consumer and telecommunication.

Mechanical Date

- Package: SOD-123FL
 Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Polarity: Cathode line denotes the cathode end

■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	G1Y
Device marking code			G1Y
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	V	1600
Maximum RMS Voltage	V _{RMS}	V	1120
Maximum DC blocking Voltage	V _{DC}	V	1600
Average rectified output current @60Hz sine wave, Resistance load, TL (FIG.1)	IO	А	1.0
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25°C			25
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C	I _{FSM} A		50
Current squared time @1ms≤t≤8.3ms Tj=25°C	l ² t	A ² s	2.6
Storage temperature	T _{stg}	°C	-55 ~ +150
Junction temperature	Tj	°C	-55 ~ +150

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

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PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	G1Y
Maximum instantaneous forward voltage	VF	V	IFM=1.0A	1.1
Maximum DC reverse current at rated DC blocking voltage	In.	4	T _j =25℃	5.0
	μA	T _j =125°C	100	
Typical junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	5.5

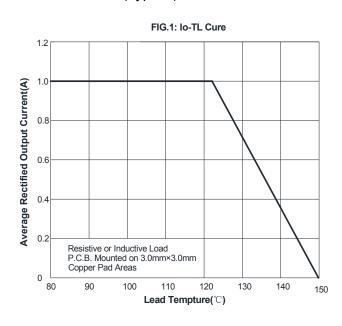


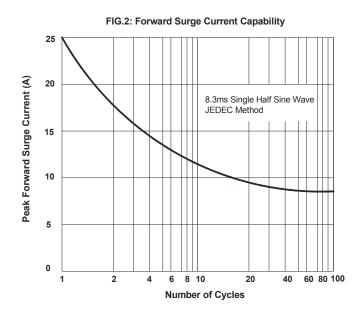
■Thermal Characteristics (Ta=25°C Unless otherwise specified)

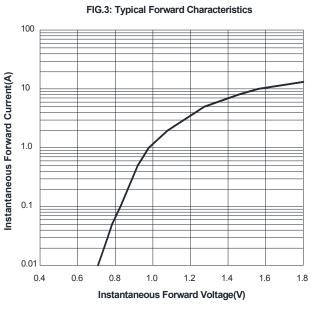
PARAMETER	SYMBOL	UNIT	G1Y
	RθJ-A ⁽¹⁾	°C/W	70
Typical Thermal resistance	RθJ-L ⁽¹⁾		20
R ₀ J-	R ₀ J-C ⁽¹⁾		18

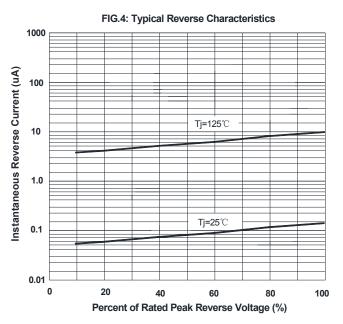
Note:

■ Characteristics(Typical)









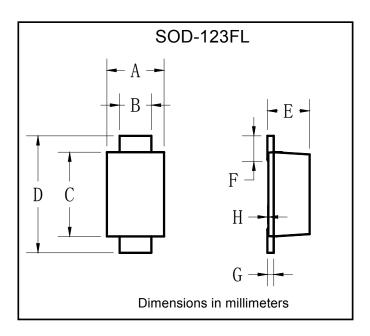
⁽¹⁾ Thermal resistance between junction and ambient and between junction and lead mounted on P.C.B with 3mm*3mm copper pad areas.



■Ordering Information (Example)

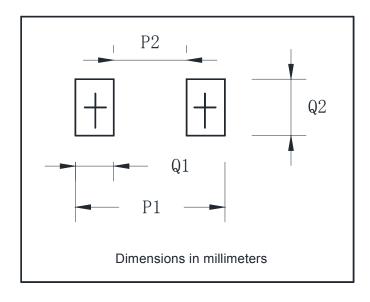
PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
G1Y	F1	Approximate 0.0169	3000	30000	120000	7" reel
G1Y	F2	Approximate 0.0169	2500	25000	100000	7" reel
G1Y	F3	Approximate 0.0169	10000	1	210000	13" reel
G1Y	F4	Approximate 0.0169	3000	54000	108000	7" reel
G1Y	F5	Approximate 0.0169	10000	1	160000	13" reel
G1Y	F6	Approximate 0.0169	3000	12000	60000	7" reel

■ Outline Dimensions



SOD-123FL				
Dim	Min	Max		
Α	1.60	1.90		
В	0.90	1.10		
С	2.55	2.85		
D	3.60	3.90		
E	1.00	1.20		
F	0.40	0.90		
G	0.10	0.25		
Н	0.02	0.05		

■ Suggested pad layout



SOD-123FL		
Dim	Millimeters	
P1	3.90	
P2	1.90	
Q1	1.00	
Q2	1.50	





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